

A Project Report

On

Design and Fabrication of Butterworth 3rd Order Lowpass Filter

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**SUBMITTED IN PARTIAL FULLFILLMENT OF THE REQUIREMENTS OF
Electromagnetic Fields and Microwave Engineering Laboratory
(ECE F312)**



BIRLA INSTITUTE OF TECHNOLOGY AND SCIENCE PILANI (RAJASTHAN)

HYDERABAD CAMPUS

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**Birla Institute of Technology and Science-Pilani,
Hyderabad Campus**

Certificate

This is to certify that the project report entitled “**Design and Fabrication of Butterworth 3rd Order Lowpass Filter**” submitted by Mr Arnav Tripathi (ID No. 2022AAPS0501H), Mr Asapu Datta Harshith (ID No. 2022A3PS0639H), Mr Soham Erande (ID No. 2022AAPS1376H), Ms Srishti Yadav (ID No. 2022AAPS0505H) in partial fulfilment of the requirements of the course Electromagnetic Fields and Microwave Engineering Laboratory (ECE F312), embodies the work done by them under my supervision and guidance.

Date: 15-04-2025

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BITS- Pilani, Hyderabad Campus

ABSTRACT

In this project, a third-order Butterworth low-pass filter with a cutoff frequency of 4 GHz is designed, simulated, and fabricated on a FR-4 substrate using microstrip technology. Standard Butterworth synthesis was used in the filter's design to produce a smooth roll-off and a maximally flat passband. Transmission line theory was used to convert lumped element values into microstrip line sections while taking substrate characteristics and real-world limitations into account. Cadence AWR was used to build and optimize the filter schematic, and PCB milling techniques were used to fabricate the final configuration. The design approach was validated by experimental measurements using a Vector Network Analyzer, which showed that the manufactured filter closely matched the simulated response with a measured -3.2 dB insertion loss at the cutoff frequency.

Minor discrepancies between theoretical and measured results were attributed to fabrication tolerances and connector losses. This work demonstrates the feasibility and effectiveness of microstrip-based Butterworth filters for RF applications and provides a practical foundation for future research in high-frequency circuit design.

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1.Theoretical Calculation for the Filter

We have to construct a Butterworth 3rd Order Lowpass Filter. We know that for a normal Butterworth Lowpass filter:

$$|H(j\omega)|^2 = \frac{1}{1 + \left(\frac{\omega}{\omega_c}\right)^{2N}}$$

Let $j\omega = s$, $\omega_c = 4$, $n = 3$

$$|H(s)|^2 = \frac{1}{1 + \left(\frac{s}{4j}\right)^6}$$

The poles will occur when $\left(\frac{s}{4j}\right)^6 = -1$.

Solving with $\omega_c = 1$ for convenience,

$(s+p_1)(s+p_2)(s+p_3)$ will be the denominator, where

$$p_i = \exp\left(j\left(\frac{2i+n-1}{2n}\pi\right)\right) \quad \text{for } i = 1, 2, 3.$$

$$\therefore p_1 = \exp\left(j\left(\frac{2+3-1}{6}\pi\right)\right) = -\frac{1}{\sqrt{2}} - \frac{j}{\sqrt{2}}$$

$$p_2 = \exp\left(j\left(\frac{4+3-1}{6}\pi\right)\right) = -\frac{1}{\sqrt{2}} + \frac{j}{\sqrt{2}}$$

$$p_3 = \exp\left(j\left(\frac{6+3-1}{6}\pi\right)\right) = -1$$

Putting these values in

$$H(s) = \frac{k}{(s + p_1)(s + p_2)(s + p_3)}$$

We get,

$$H(s) = \frac{k}{\left(s + \frac{1}{\sqrt{2}} + \frac{j}{\sqrt{2}}\right)\left(s + \frac{1}{\sqrt{2}} - \frac{j}{\sqrt{2}}\right)(s + 1)}$$

$$H(s) = \frac{k}{(s^2 + \sqrt{2}s + 1)(s + 1)}$$

$$H(s) = \frac{k}{(s^3 + \sqrt{2}s^2 + s + 1)}$$

But this is for $\omega_c = 1$, for $\omega_c = 4$, we will replace s by $\frac{s}{\omega_c}$

$$H(s) = \frac{k}{\left(\left(\frac{s}{\omega_c}\right)^3 + \sqrt{2}\left(\frac{s}{\omega_c}\right)^2 + \frac{s}{\omega_c} + 1\right)}$$

Putting in the value, we get

$$H(s) = \frac{(4 * 10^3)^3}{(s^3 + \sqrt{2}(4 * 10^3)s^2 + (4 * 10^3)^2s + (4 * 10^3)^3)}$$

$$H(s) = \frac{64 * 10^{27}}{(s^3 + 5.656 * 10^3s^2 + 16 * 10^8s + 64 * 10^{27})}$$

Based on these calculations, standardised $g_1 = 1$ (for Inductor 1), $g_2 = 2$ (for Capacitor 1), $g_3 = 1$ (for Inductor 2).

Value of inductors:

$$L_1 = \frac{g_1 Z_o}{\omega_c} = \frac{50 * 1}{2\pi * 4 * 10^9} \approx 1.99nH$$

$$C_1 = \frac{g_2}{Z_o \omega_c} = \frac{2}{50 * 2\pi * 4 * 10^9} \approx 1.5915 pF$$

$$L_2 = L_1 = 1.99 nH$$

For MLIN,

$$L = \frac{Z_o L_{eff}}{v_p}$$

$$v_p = \frac{c}{\sqrt{\epsilon_{eff}}} = \frac{3 * 10^8}{\sqrt{4.4}} = 1.825 * 10^8 \text{ m/s}$$

Solving for L_{eff} ,

$$L_{eff} = \frac{Lv_p}{Z_o} = \frac{1.99 * 10^9 * 1.825 * 10^8}{50} = 7.25mm$$

Width: Assuming $\frac{W}{h} > 2$

$$Z_o = \frac{120\pi}{\sqrt{\epsilon_{eff}} \left(\frac{W}{h} + 1.393 + 0.667 \ln \left(\frac{W}{h} + 1.444 \right) \right)}$$

$$\epsilon_{eff} = \frac{\epsilon_r + 1}{2} + \frac{\epsilon_r - 1}{2} \times \left(\frac{1}{\sqrt{1 + \frac{12h}{W}}} \right)$$

Given that, substrate height $h = 1.6$ mm. Substituting in the equation:

$$\epsilon_{eff} = \frac{\epsilon_r + 1}{2} + \frac{\epsilon_r - 1}{2} \times \left(\frac{1}{\sqrt{1 + \frac{19.2}{W}}} \right)$$



Can be ignored as denominator \gg numerator

Given that: $Z_o = 50 \Omega$

Assuming $\epsilon_{eff} = 2.7$

$$50 = \frac{120\pi}{\sqrt{2.7} \left(\frac{W}{1.6} + 1.393 + 0.667 \ln \left(\frac{W}{1.6} + 1.444 \right) \right)}$$

Solving for W , we get $W \approx 3$ mm.

For the capacitor, $X_{stub} = -Z_o \cot(\beta l)$

$$X_c = \frac{1}{\omega_c} \text{ (high frequency, small length)}$$

$$\therefore \frac{1}{\omega_c} = Z_o \cot(\beta l)$$

$$\beta l = \cot^{-1} \left(\frac{1}{\omega_c Z_o} \right) = \cot^{-1}(0.5) \approx 1.107 \text{ rad}$$

(As $C = 1.59$ pF, $\omega_c = 8\pi \times 10^9$, $Z_o = 50 \Omega$)

$$\beta = \frac{2\pi}{\lambda_g}$$

$$\lambda_g = \frac{c}{f \times \sqrt{\epsilon_{eff}}} = \frac{3 \times 10^8}{4 \times 10^9 \times \sqrt{2.7}} = 45.7 \text{ mm}$$

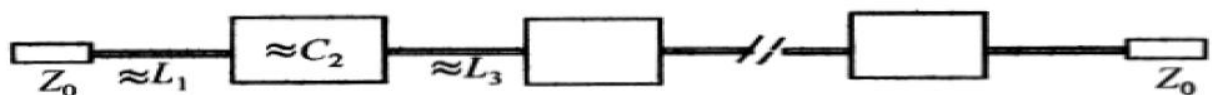
$$l = \frac{\beta l \times \lambda_g}{2\pi} = \frac{1.107 \times 45.7}{2\pi} = 8.054 \text{ mm}$$

The inductor and capacitor's width calculations are the same, so $W \approx 3\text{mm}$.

2.Design and Simulation of the Filter

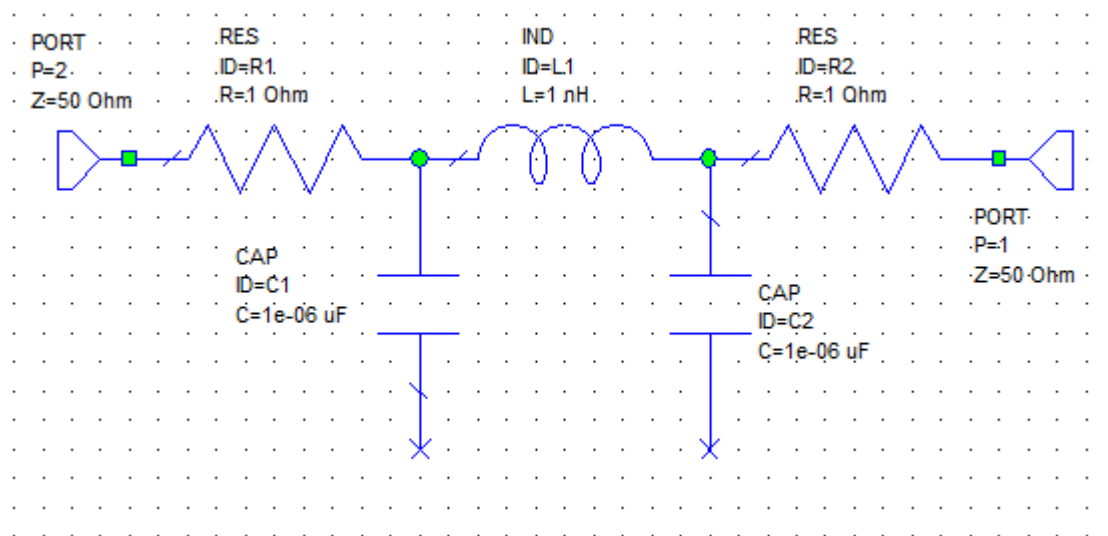
2.1 Designing the Filter

A low-pass Butterworth filter can be constructed using a ladder of inductors and capacitors between the source and the load. The number of elements affects the order of the filter we design. (No. of elements = Order)



Above is a generalised model for a Butterworth LPF. For order $n = 3$, we have 2 capacitors with an inductor in between (as shown below, ignore values)

Using Cadence AWR, the schematic can be made as follows:



EXTRACT

- ID=EX1
- EM_Doc="EM_Extract_Doc"
- Name="EM_Extract"
- Simulator=AXIEM
- X_Cell_Size=0.3 mm
- Y_Cell_Size=0.3 mm
- STACKUP="SUB2"
- Override_Options=Yes
- Hierarchy=Off
- SweepVar_Names=""

STACKUP
Name=SUB2

PORT
P=1
Z=50 Ohm

MLIN
ID=TL1
W=W1 mm
L=L1 mm

MSUB=SUB1

MTEES
ID=TL2
L=L2 mm

MLIN
ID=TL3
W=W2 mm
L=L2 mm

MSUB=SUB1

MTEES
ID=TL4
L=L3 mm

MLIN
ID=TL5
W=W1 mm
L=L1 mm

MSUB=SUB1

PORT
P=2
Z=50 Ohm

MSUB
Er=4.4
H=1.6 mm
T=0.035 mm
Rho=1
Tand=0
ErNom=4.4
Name=SUB1

MLEF
ID=TL6
W=W3 mm
L=L3 mm
MSUB=SUB1

MLEF
ID=TL7
W=W3 mm
L=L3 mm
MSUB=SUB1

L1=20.3
W1=2.834

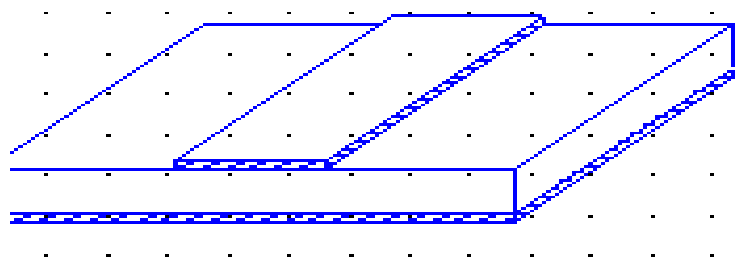
L2=10.5
W2=2.284

L3=5.823
W3=1.905

- TL1, TL5 signify resistances, TL3 signifies inductor. TL6, and TL7 signify the capacitors.
- The lengths of W1, W2, W3, L1, L2, and L3 are determined after tuning them for optimal results, ie. Getting $|S(2,1)(dB)|$ as close to -3dB at 4GHz frequency.
- The ports are at $Z_0 = 50\Omega$.

Details of the substrate:-

MSUB
Er=4.4
H=1.6 mm
T=0.035 mm
Rho=1
Tand=0
ErNom=4.4
Name=SUB1



TXLine values:-

TXLINE 2003 - Microstrip

Microstrip | Stripline | CPW | CPW Ground | Round Coaxial | Slotline | Coupled MSLine | Coupled Stripline

Material Parameters

Dielectric: GaAs
Dielectric Constant: 4.4
Loss Tangent: 0.0005

Conductor: Silver
Conductivity: 6.14E+07 S/m

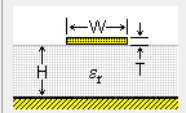
AWR

Electrical Characteristics

Impedance: 50 Ohms
Frequency: 10 GHz
Electrical Length: 90 deg
Phase Constant: 180 deg/m
Effective Diel. Const.: 10
Loss: 10 dB/m

Physical Characteristic

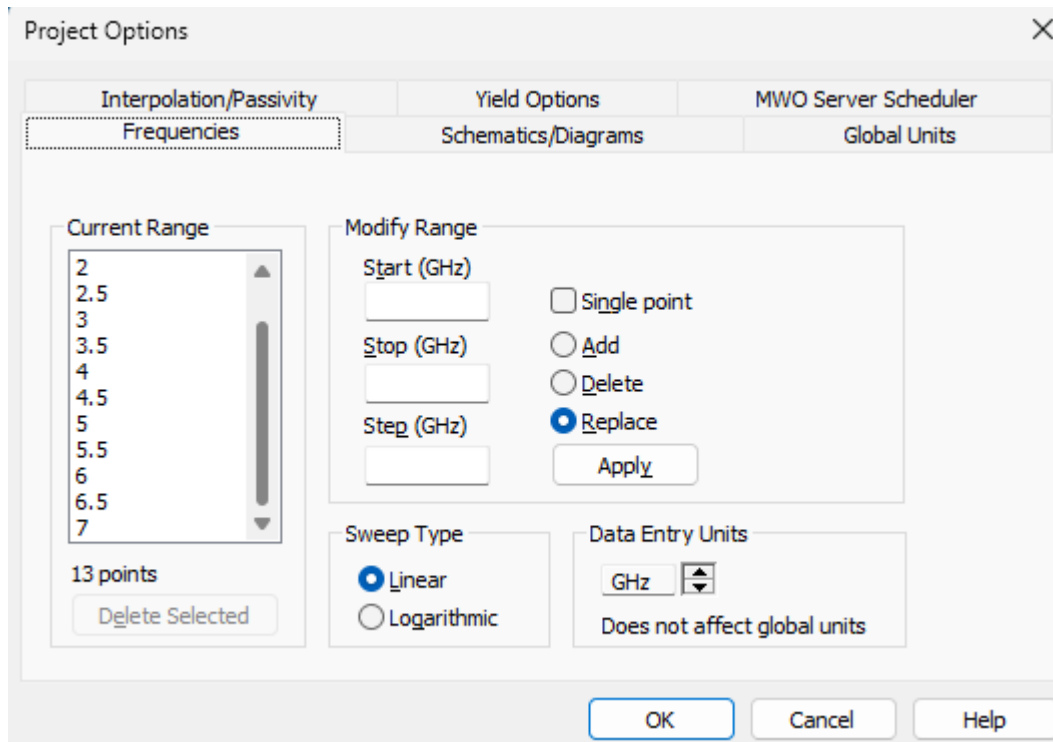
Physical Length (L): 20.302 mm
Width (W): 3.04374 mm
Height (H): 1.6 mm
Thickness (T): 0.035 mm



We input the values of Impedance, Frequency, and Electrical Length to get the calculated values of physical characteristics like length(L) and width(W).

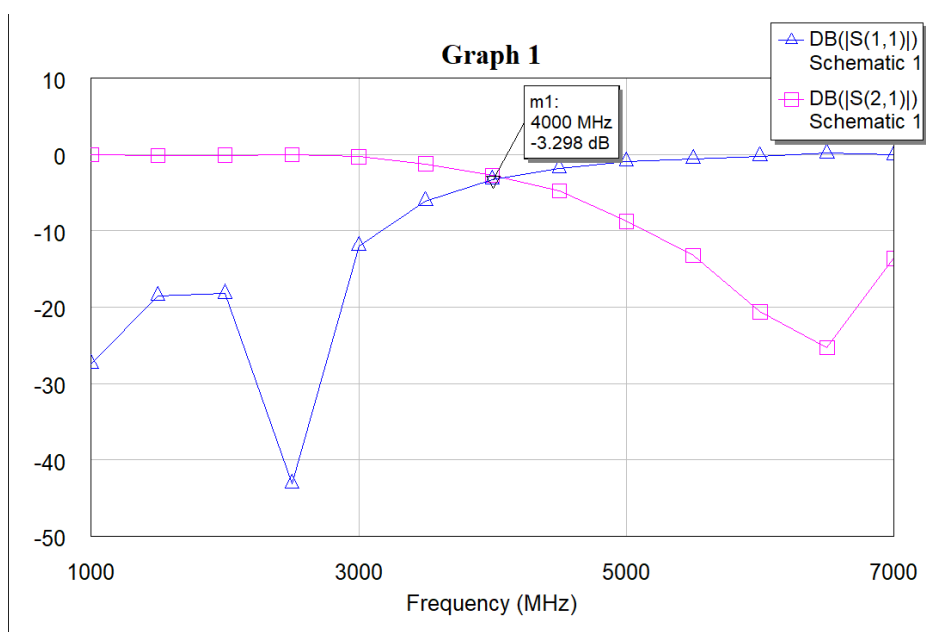
2.2 Simulating the Filter

Sweep parameters:-



Since our cutoff frequency is 4GHz, we sweep from 2GHz to 7GHz.

Simulation Result:-



$|S(1,1)(\text{dB})|$ signifies the magnitude of reflection received at port 1.

While, $|S(2,1)(\text{dB})|$ indicated the power received at port 2, coming from port 1. It is seen that the $|S(2,1)(\text{dB})|$ follows typical Butterworth filter characteristics.

In an ideal scenario, $|S(2,1)(\text{dB})|$ should be equal to -3dB at 4GHz frequency.

Element Options:-

Material Definitions

Element Options: STACKUP - Multi-Layer Substrate Definition Properties

Material Defs. Dielectric Layers Materials EM Layer Mapping Line Type Parameters User Attributes Symbol Rules

Dielectric Definitions: (use for dielectric layers)

Name	Er	TanD	Color	Advanced Properties
SUB1	4.4	0		Advanced: Er=4.4, TanD=0, Sigma=0, Ur=1, TanM=0

Conductor Definitions: (use for conductors, vias, and/or top/bottom boundary conditions)

Name	Sigma	Color	Advanced Properties
Gold	4.25e+07		Advanced: Er=1, TanD=0, Sigma=42600000, Ur=1, TanM=0
Copper	5.96e+07		Advanced: Er=1, TanD=0, Sigma=59.6e6, Ur=1, TanM=0

Impedance Definitions: (use for conductors, vias, and/or top/bottom boundary conditions)

Name	ResSq	ResF	React	Color
------	-------	------	-------	-------

Defaults: (Air, Perfect Conductor, Approx Open, Inf WG)

Name	Color
Air	No Fill
Perfect Conductor	
Approx Open	No Fill
Inf WG	No Fill

OK Cancel Help Element Help Vendor Help

Dielectric Layers

Element Options: STACKUP - Multi-Layer Substrate Definition Properties

Material Defs. Dielectric Layers Materials EM Layer Mapping Line Type Parameters User Attributes Symbol Rules

Dielectric materials in the stackup (thickness specified in mm)

Layer	Thickness	Material Definition	Draw Scale
1	16	Air	1
2	1.6	SUB1	1

Substrate Name: SUB2

Top Boundary: Approx Open Bottom Boundary: Copper

Side Boundary: Copper

Materials

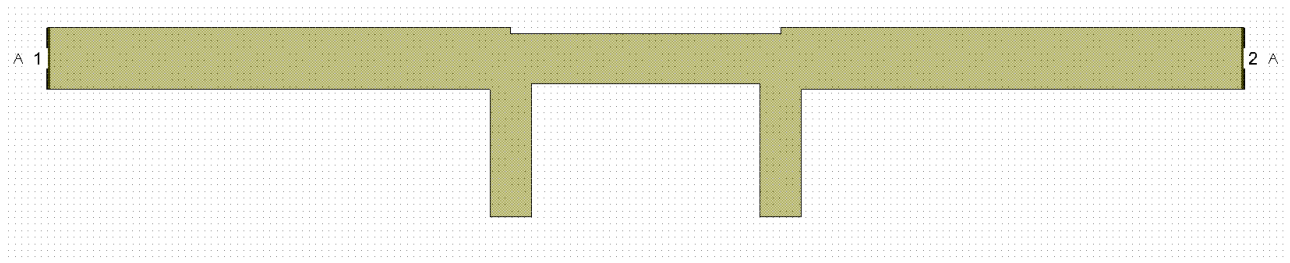
Element Options: STACKUP - Multi-Layer Substrate Definition Properties

Material Defs. Dielectric Layers **Materials** EM Layer Mapping Line Type Parameters User Attributes Symbol Rules

Material properties for conductors, vias, etc... (thickness specified in mm)

Name	Thickness	Material Definition	Etch Angle	Roughness	Solve Inside
Perfect Conductor	0.035	Perfect Conductor	0	0	<input type="checkbox"/>
Cu	0.035	Copper	0	0	<input type="checkbox"/>

EM Extract Layout:-



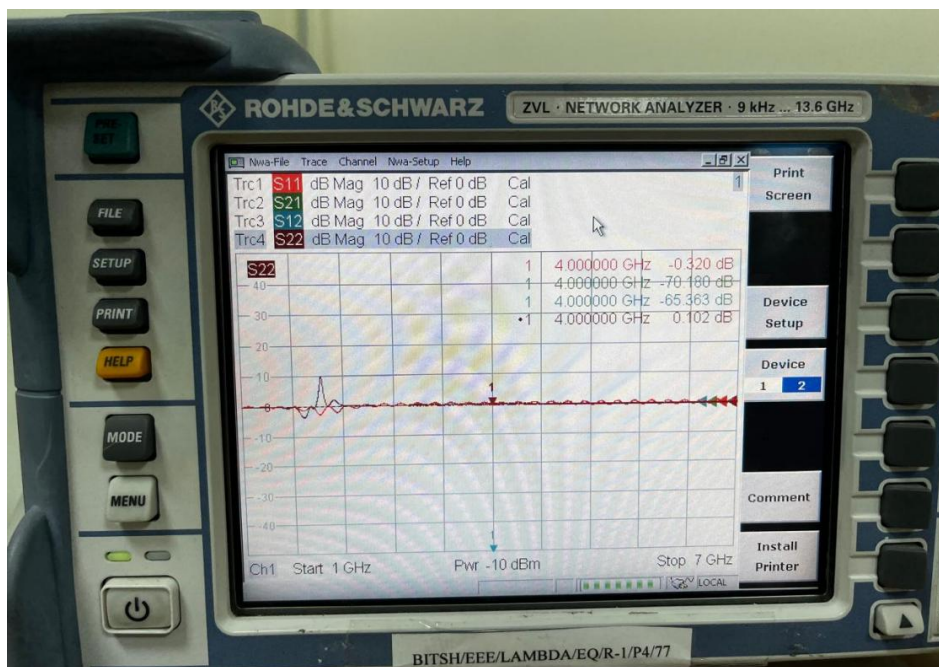
3. Fabrication of the Filter

The above design was converted into a Gerber file and then fabricated in the LAMBDA lab milling machine. After the substrate was etched, the terminal ports were soldered to enable usability.

The final filter looked like this:



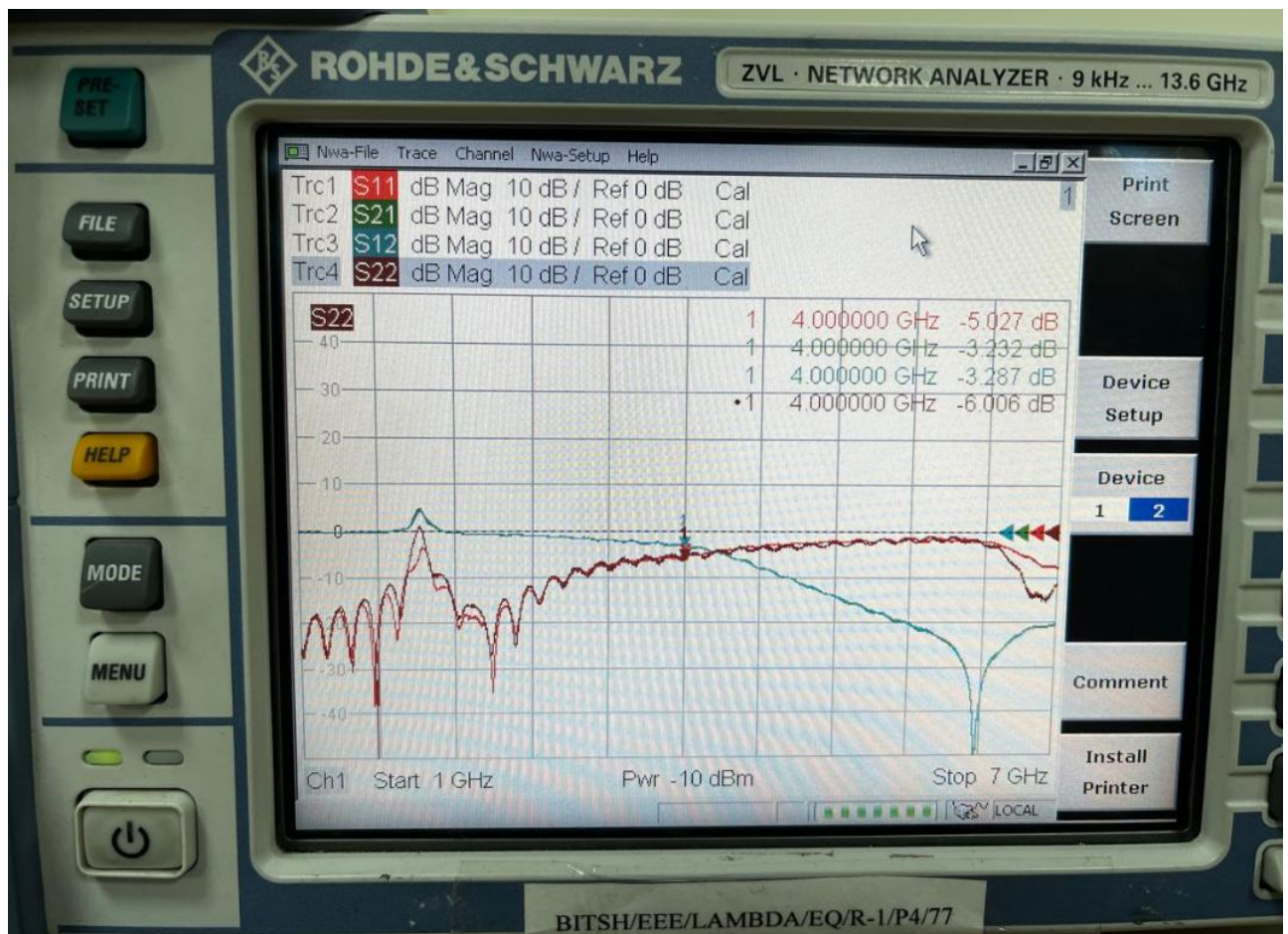
First, we removed the noise gain from the wires of the Vector Network Analyser (VNA) and brought them to zero to minimise system error as shown:



The filter was then connected to it:



The plotted S_{21} and S_{11} graphs are as shown below:



There is a small peak in the passband of the filter as seen in the result. This peak is coming because the machine was unable to perfectly tune the case where no load is applied. We should ideally see a flat line throughout, but there is a peak at the same position where the peak is occurring in the passband.

CONCLUSION

In this work, a third-order Butterworth low-pass filter with a 2 GHz cutoff was designed, simulated, and analyzed using microstrip technology on an FR-4 substrate. The design followed the standard Butterworth approach to ensure a flat passband and a smooth transition to the stopband. Lumped LC elements were translated into microstrip line sections using transmission line theory, with careful consideration of the substrate's properties and practical constraints—such as the challenges of implementing shunt stubs in microstrip form.

From the graph plotted by the VNA, we can observe that the plot resembles a 3rd order lowpass Butterworth filter. The cutoff frequency can be seen as a little less than 4GHz, which was the value assigned to our group. This minute error can be accounted to the errors in the fabrication process (routing and soldering). The gain observed at the 4GHZ frequency is -3.2 dB, which is very close to the theoretical -3dB value.

Overall, this project demonstrated that it is feasible to realize a compact and effective third-order low-pass filter for RF applications using cost-effective FR-4 material. The process offered valuable experience in the design, optimization, and simulation of microstrip filters, laying a solid foundation for future research in high-frequency communications.

References:

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